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# **PRODUCT OVERVIEW**

# **OVERVIEW**

The S3C72M5/C72M7/C72M9 single-chip CMOS microcontroller has been designed for high performance using Samsung's newest 4-bit CPU core, SAM47 (Samsung Arrangeable Microcontrollers).

With an up-to-1280-dot LCD direct drive capability, segment expandable circuit, 8-bit and 16-bit timer/counter, and serial I/O, the S3C72M5/C72M7/C72M9 offers an excellent design solution for a wide variety of applications which require LCD functions.

Up to 51 pins of the 128-pin QFP package can be dedicated to I/O. Nine vectored interrupts provide fast response to internal and external events. In addition, the S3C72M5/C72M7/C72M9's advanced CMOS technology provides for low power consumption and a wide operating voltage range.

# **OTP**

The S3C72M5/C72M7/C72M9 microcontroller is also available in OTP (One Time Programmable) version, S3P72M9. S3P72M9 microcontroller has an on-chip 32-Kbyte one-time-programmable EPROM instead of masked ROM. The S3P72M9 is comparable to S3C72M5/C72M7/C72M9, both in function and in pin configuration except ROM size.



### FEATURES SUMMARY

### Memory

- 3,584 × 4-bit RAM (Excluding LCD Display RAM)
- 16,384/24,576/32,768 × 8-bit ROM

### 51 I/O Pins

- I/O: 47 pins (32 pins are configurable as SEG pins)
- Input only: 4 pins

### **LCD Controller/Driver**

- 80 SEG × 16 COM, 88 SEG × 8 COM Terminals
- Internal resistor circuit for LCD bias
- 16 Level LCD contrast control (software)
- · Segment expandable circuit
- All dot can be switched on/off

### 8-bit Basic Timer

- 4 interval timer functions
- Watch-dog timer

# 8-bit Timer/Counter

- Programmable 8-bit timer
- · External event counter
- Arbitrary clock frequency output
- External clock signal divider

### 16-Bit Timer/Counter

- Programmable 16-bit timer
- External event counter
- Arbitrary clock frequency output
- External clock signal divider
- Configurable as two 8-bit Timers
- Serial I/O interface clock generator

### **Watch Timer**

- Time interval generation:
   0.5 s, 3.9 ms at 32,768 Hz
- 4 frequency outputs to BUZ pin
- Clock source generation for LCD

### 8-bit Serial I/O Interface

- 8-bit transmit/receive mode
- 8-bit receive mode
- LSB-first or MSB-first transmission selectable
- Internal or external clock source

# Comparator

- 3 Channel mode: internal reference (4-bit resolution)
- 2 Channel mode: external reference

### Interrupts

- Five internal vectored interrupts
- Four external vectored interrupts
- Two quasi-interrupts

### **Bit Sequential Carrier**

 Supports 16-bit serial data transfer in arbitrary format

# **Memory-Mapped I/O Structure**

Data memory bank 15

### **Power-Down Modes**

- Idle mode (only CPU clock stops)
- Stop mode (main system clock stops)
- Subsystem clock stop mode

### **Oscillation Sources**

- Crystal, Ceramic or RC for main system clock
- Crystal oscillator for subsystem clock
- Main system clock frequency: 0.4–6 MHz
- Subsystem clock frequency: 32.768 kHz
- CPU clock divider circuit (by 4, 8 or 64)

### **Instruction Execution Times**

- 0.67, 1.33, 10.7 µs at 6 MHz
- 0.95, 1.91, 15.3 μs at 4.19
   MHz
- 122 µs at 32.768 kHz

# **Operating Temperature**

• -40 °C to 85 °C

# **Operating Voltage Range**

1.8 V to 5.5 V

# **Package Type**

• 128-pin QFP



### **FUNCTION OVERVIEW**

### SAM47 CPU

All KS57-series microcontrollers have the advanced SAM47 CPU core. The SAM47 CPU can directly address up to 32 K bytes of program memory. The arithmetic logic unit (ALU) performs 4-bit addition, subtraction, logical, and shift-and-rotate operations in one instruction cycle and most 8-bit arithmetic and logical operations in two cycles.

### **CPU REGISTERS**

### **Program Counter**

A 15-bit program counter (PC) stores addresses for instruction fetches during program execution. Usually, the PC is incremented by the number of bytes of the fetched instruction. The one instruction fetch that does not increment the PC is the 1-byte REF instruction which references instructions stored in a look-up table in the ROM. Whenever a reset operation or an interrupt occurs, bits PC13 through PC0 are set to the vector address.

### **Stack Pointer**

An 8-bit stack pointer (SP) stores addresses for stack operations. The stack area is located in general-purpose data memory bank 0. The SP is 8-bit read/writeable and SP bit 0 must always be logical zero.

During an interrupt or a subroutine call, the PC value and the PSW are written to the stack area. When the service routine has completed, the values referenced by the stack pointer are restored. Then, the next instruction is executed.

The stack pointer can access the stack despite data memory access enable flag status. Since the reset value of the stack pointer is not defined in firmware, you use program code to initialize the stack pointer to 00H. This sets the first register of the stack area to data memory location 0FFH.

### **PROGRAM MEMORY**

In its standard configuration, the  $16,384/24,576/32,768 \times 8$ -bit ROM is divided into four areas:

- 16-byte area for vector addresses
- 96-byte instruction reference area
- 16-byte general-purpose area (0010–001FH)
- 16,256/24,448/32,640-byte area for general-purpose program memory

The vector address area is used mostly during reset operations and interrupts. These 16 bytes can alternately be used as general-purpose ROM.

The REF instruction references 2 x 1-byte or 2-byte instructions stored in reference area locations 0020H–007FH. REF can also reference three-byte instructions such as JP or CALL. So that a REF instruction can reference these instructions, however, the JP or CALL must be shortened to a 2-byte format. To do this, JP or CALL is written to the reference area with the format TJP or TCALL instead of the normal instruction name. Unused locations in the REF instruction look-up area can be allocated to general-purpose use.



### **DATA MEMORY**

### Overview

The 3,584-bit data memory has five areas:

- 32Ê Ê Â-bit working register area
- 224Ê 4-bit general-purpose area in bank 0 which is also used as the stack area
- 256Ê 4-bit general-purpose area in bank 1, bank 2,....bank 13, respectively
- 256Ê 5-bit area for LCD data in bank 14
- 128Ê '4-bit area in bank 15 for memory-mapped I/O addresses

The data memory area is also organized as sixteen memory banks —bank 0, bank 1, ..., and bank 15. You use the select memory bank instruction (SMB) to select one of the banks as working data memory.

Data stored in RAM locations are 1-, 4-, and 8-bit addressable. After a hardware reset, data memory initialization values must be defined by program code.

### **Data Memory Addressing Modes**

The enable memory bank (EMB) flag controls the addressing mode for data memory banks 0, 1, ..., or 15. When the EMB flag is logical zero, only locations 00H–7FH of bank 0 and bank 15 can be accessed. When the EMB flag is set to logical one, all sixteen data memory banks can be accessed based on the current SMB value.

### **Working Registers**

The RAM's working register area in data memory bank 0 is also divided into four *register* banks. Each register bank has eight 4-bit registers. Paired 4-bit registers are 8-bit addressable.

Register A can be used as a 4-bit accumulator and double register EA as an 8-bit extended accumulator; double registers WX, WL and HL are used as address pointers for indirect addressing.

To limit the possibility of data corruption due to incorrect register addressing, it is advisable to use bank 0 for main programs and banks 1, 2, and 3 for interrupt service routines.

# **LCD Data Register Area**

Bit values for LCD segment data are stored in data memory bank 14. Register locations that are not used to store LCD data can be assigned to general-purpose use.

# **Bit Sequential Carrier**

The bit sequential carrier (BSC) is a 16-bit general register that you can manipulate using 1-, 4-, and 8-bit RAM control instructions.

Using the BSC register, addresses and bit locations can be specified sequentially using 1-bit indirect addressing instructions. In this way, a program can generate 16-bit data output by moving the bit location sequentially, incrementing or decrementing the value of the L register. You can also use direct addressing to manipulate data in the BSC.



### **CONTROL REGISTERS**

# **Program Status Word**

The 8-bit program status word (PSW) controls ALU operations and instruction execution sequencing. It is also used to restore a program's execution environment when an interrupt has been serviced. Program instructions can always address the PSW regardless of the current value of data memory access enable flags.

Before an interrupt is processed, the PSW is pushed onto the stack in data memory bank 0. When the routine is completed, PSW values are restored.

| IS1 | IS0 | EMB | ERB |
|-----|-----|-----|-----|
| С   | SC2 | SC1 | SC0 |

Interrupt status flags (IS1, IS0), the enable memory bank and enable register bank flags (EMB, ERB), and the carry flag (C) are 1- and 4-bit read/write or 8-bit read-only addressable. Skip condition flags (SC0–SC2) can be addressed using 8-bit read instructions only.

# Select Bank (SB) Register

Two 4-bit locations called the SB register store address values used to access specific memory and register banks: the select memory bank register, SMB, and the select register bank register, SRB.

'SMB n' instructions select a data memory bank (0, 1, ..., or 15) and store the upper four bits of the 12-bit data memory address in the SMB register. The 'SRB n' instruction is used to select register bank 0, 1, 2, or 3, and to store the address data in the SRB.

The instructions 'PUSH SB' and 'POP SB' move SMB and SRB values to and from the stack for interrupts and subroutines.

### **CLOCK CIRCUITS**

Main system and subsystem oscillation circuits generate the internal clock signals for the CPU and peripheral hardware. The main system clock can use a Crystal, Ceramic, or RC oscillation source, or an externally-generated clock signal. The subsystem clock requires either a crystal oscillator or an external clock source.

Bit settings in the 4-bit power control and system clock mode registers select the oscillation source, the CPU clock, and the clock used during power-down mode. The internal system clock signal (fxx) can be divided internally to produce four CPU clock frequencies—fx/4, fx/8, fx/64, or fxt/4.

# **INTERRUPTS**

Interrupt requests may be generated internally by on-chip processes (INTB, INTT0, INTT1, and INTS) or externally by peripheral devices (INT0, INT1, INT4, and INTK). There are two quasi-interrupts: INT2 and INTW.

INT2 detects rising or falling edges of incoming signals and INTW detects time intervals of 0.5 seconds or 3.91 milliseconds. The following components support interrupt processing:

- Interrupt enable flags
- Interrupt request flags
- Interrupt priority registers
- Power-down termination circuit



### **POWER DOWN**

To reduce power consumption, there are two power-down modes: idle and stop. The IDLE instruction initiates idle mode and the STOP instruction initiates stop mode.

In idle mode, only the CPU clock stops while peripherals and the oscillation source continue to operate normally. Stop mode effects only the main system clock —a subsystem clock, if used, continues oscillating. In stop mode, main system clock oscillation stops completely, halting all operations except for a few basic peripheral functions. RESET or an interrupt can be used to terminate either idle or stop mode.

### RESET

When a RESET signal occurs during normal operation or during power-down mode, the CPU enters idle mode when the reset operation is initiated. When the standard oscillation stabilization interval (31.3 ms at 4.19 MHz) has elapsed, normal CPU operation resumes.

# I/O PORTS

The S3C72M5/C72M7/C72M9 has 13 I/O ports. Pin addresses for all I/O ports are mapped in bank 15 of the RAM. There are 4 input pins and 47 configurable I/O pins for a total of 51 I/O pins. The contents of I/O port pin latches can be read, written, or tested at the corresponding address using bit manipulation instructions.

# **TIMERS and TIMER/COUNTERS**

The timer function has four main components: an 8-bit basic interval timer, an 8-bit timer/counter, a 16-bit timer/counter and a watch timer. The 8-bit basic timer generates interrupt requests at precise intervals, based on the selected clock frequency and has watch-dog timer function.

The programmable 8-bit and 16-bit timer/counters are used for external event counting, generation of arbitrary clock frequencies for output, and dividing external clock signals. The 16-bit timer/counter is the source of the clock signal that is required to drive the serial I/O interface and configurable as two 8-bit timer/counters.

The watch timer has an 8-bit watch timer mode register, a clock selector and a frequency divider circuit. Its functions include real-time and watch-time measurement, clock generation for the LCD controller and frequency outputs for buzzer sound.



### LCD DRIVER/CONTROLLER

The S3C72M5/C72M7/C72M9 can directly drive an up-to-1,280-dot LCD panel. The LCD function block has the following components:

- RAM area for storing display data
- 80 segment output pins (SEG0–SEG79)
- Segment expandable circuit
- 16 common output pins (COM0–COM15)
- 5 operating power supply pins (V<sub>I C1</sub>-V<sub>I C5</sub>)
- Sixteen level LCD contrast control circuit (software)

Frame frequency, LCD clock, duty, and segment pins used for display output are controlled by bit settings in the 8-bit mode register, LMOD. You use the 4-bit LCD control register, LCON, to turn the LCD display on and off, and to control current supplied to the dividing resistors. Segment data are output using a direct memory access method synchronized with the LCD frame frequency (f<sub>I CD</sub>).

Using the main system clock, the LCD panel operates in idle mode; during stop mode, it is turned off. If a subsystem clock is used as a clock source, the LCD panel will continue to operate during stop and idle modes.

### **SERIAL I/O INTERFACE**

The serial I/O interface supports the transmission or reception of 8-bit serial data with an external device. The serial interface has the following functional components:

- 8-bit mode register
- Clock selector circuit
- 8-bit buffer register
- 3-bit serial clock counter

The serial I/O circuit can be set either to transmit-and-receive or to receive-only mode. MSB-first or LSB-first transmission is also selectable. The serial interface operates with an internal or an external clock source, or using the clock signal generated by the 16-bit timer/counter. To modify transmission frequency, the appropriate bits in the serial I/O mode register (SMOD) must be manipulated.

# **COMPARATOR**

Port 4 can be used as a analog input port for a comparator. The reference voltage for the 3-channel comparator can be supplied either internally or externally at P4.2. The comparator module has the following components:

- Comparator
- Internal reference voltage generator (4-bit resolution)
- External reference voltage source at P4.2
- Comparator mode register (CMOD)
- Comparison result register (CMPREG)



### **BLOCK DIAGRAM**

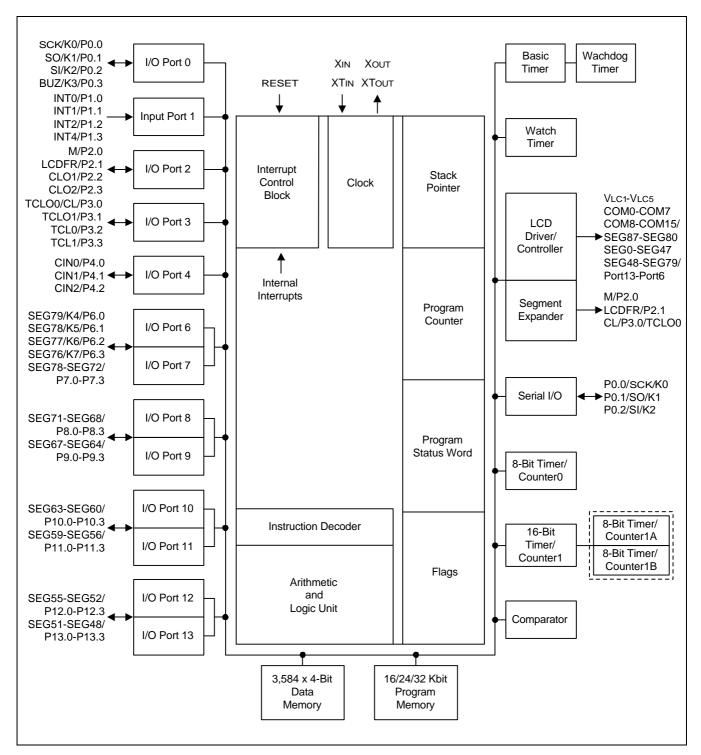


Figure 1-1. S3C72M5/C72M7/C72M9 Simplified Block Diagram



### PIN ASSIGNMENTS

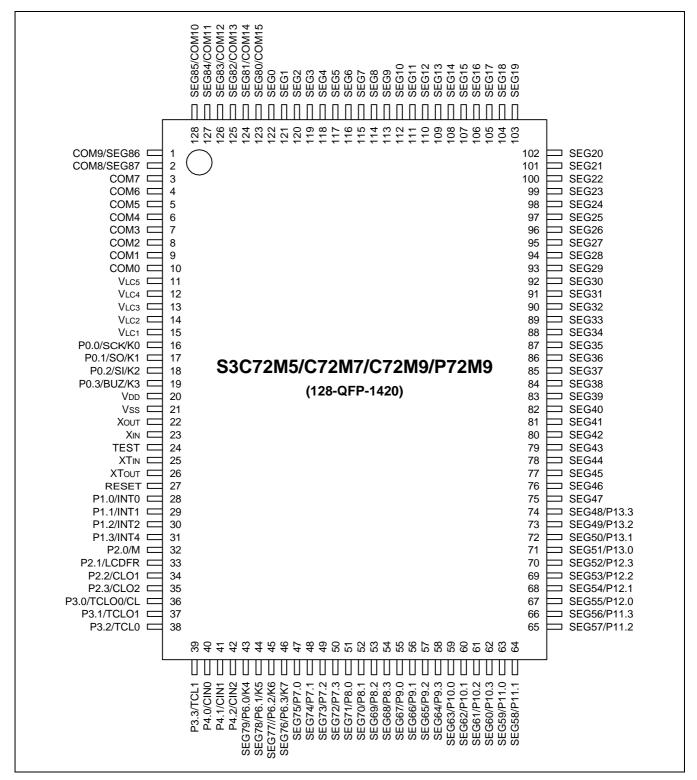


Figure 1-2. S3C72M5/C72M7/C72M9 128-QFP Pin Assignment



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# **PIN DESCRIPTIONS**

Table 1-1. S3C72M5/C72M7/C72M9 Pin Descriptions

| Pin Name                                  | Pin Type | Description  | Number                        | Share Pin  |
|---|----------|--|-------------------------------|--|
| P0.0<br>P0.1<br>P0.2<br>P0.3              | I/O      | 4-bit I/O port. 1-bit and 4-bit read/write and test is possible. 4-bit unit pull-up resisters are assignable to input pins by software and are automatically disabled for output pins. Each bit pin can be allocated as input or output (1-bit unit). The N-ch open drain or push-pull output may be selected by software (1-bit unit).    | 16<br>17<br>18<br>19          | SCK/K0<br>SO/K1<br>SI/K2<br>BUZ/K3                       |
| P1.0<br>P1.1<br>P1.2<br>P1.3              | l        | <ul><li>4-bit input port.</li><li>1-bit and 4-bit read and test is possible.</li><li>4-bit unit pull-up resistors are assignable to input pins by software.</li></ul>  | 28<br>29<br>30<br>31          | INT0<br>INT1<br>INT2<br>INT4                             |
| P2.0<br>P2.1<br>P2.2<br>P2.3              | I/O      | 4-bit I/O port. 1-bit and 4-bit read/write and test is possible. I/O function is same as port 0.   | 32<br>33<br>34<br>35          | M<br>LCDFR<br>CLO1<br>CLO2                               |
| P3.0<br>P3.1<br>P3.2<br>P3.3              | I/O      | 4-bit I/O port. 1-bit and 4-bit read/write and test is possible. I/O function is same as port 0.   | 36<br>37<br>38<br>39          | TCLO0/CL<br>TCLO1<br>TCL0<br>TCL1                        |
| P4.0<br>P4.1<br>P4.2                      | I/O      | 3-bit I/O port. I/O function is same as port 0 except that port 4 is 3-bit I/O port.   | 40<br>41<br>42                | CIN0<br>CIN1<br>CIN2                                     |
| P6.0<br>P6.1<br>P6.2<br>P6.3<br>P7.0–P7.3 | I/O      | 4-bit I/O port. 1-, 4-bit and 8-bit read/write and test is possible. 4-bit unit pull-up resisters are assignable to input pins by software and are automatically disabled for output pins. Each bit pin can be allocated as input or output (1-bit unit). The N-ch open drain or pushpull output may be selected by software (4-bit unit). | 43<br>44<br>45<br>46<br>47–50 | K4/SEG79<br>K5/SEG78<br>K6/SEG77<br>K7/SEG76<br>SEG75–72 |
| P8.0-P8.3<br>P9.0-P9.3                    | I/O      | 4-bit I/O port. 1-, 4-bit and 8-bit read/write and test is possible. I/O function is same as port 6, 7.  | 51–54<br>55–58                | SEG71–68<br>SEG67–64                                     |
| P10.0-P10.3<br>P11.0-P11.3                | I/O      | 4-bit I/O port. 1-, 4-bit and 8-bit read/write and test is possible. I/O function is same as port 6, 7.  | 59–62<br>63–66                | SEG63-60<br>SEG59-56                                     |
| P12.0-P12.3<br>P13.0-P13.3                | I/O      | 4-bit I/O port. 1-, 4-bit and 8-bit read/write and test is possible. I/O function is same as port 6, 7.  | 67–70<br>71–74                | SEG55-52<br>SEG51-48                                     |
| SCK                                       | I/O      | Serial I/O interface clock signal  | 16                            | P0.0   |
| SO  | I/O      | Serial data output   | 17                            | P0.1   |
| SI  | I/O      | Serial data input  | 18                            | P0.2   |
| BUZ                                       | I/O      | 2, 4, 8, 16 kHz frequency output for buzzer sound  | 19                            | P0.3   |
| K0-K3<br>K4-K7                            | I/O      | External interrupts with rising/falling edge detection   | 16–19<br>43–46                | P0.0–P0.3<br>P6.0–P6.3                                   |



Table 1-1. S3C72M5/C72M7/C72M9 Pin Descriptions (Continued)

| Pin Name                             | Pin Type | Description   | Number          | Share Pin         |
|--------------------------------------|----------|---|-----------------|-------------------|
| INT0                                 | I        | External interrupts with rising/falling edge detection                              | 28              | P1.0              |
| INT1                                 | I        | External interrupts with rising/falling edge detection                              | 29              | P1.1              |
| INT2                                 | I        | External quasi-interrupts with rising/falling edge detection                        | 30              | P1.2              |
| INT4                                 | I        | External interrupts with rising/falling edge detection                              | 31              | P1.3              |
| M                                    | I/O      | Alternated signal for SEG driver  | 32              | P2.0              |
| LCDFR                                | I/O      | Synchronous frame signal for SEG driver   | 33              | P2.1              |
| CLO1                                 | I/O      | Clock output or operating clock for SEG driver                                      | 34              | P2.2              |
| CLO2                                 | I/O      | Clock output or operating clock for SEG driver                                      | 35              | P2.3              |
| CL                                   | I/O      | Data shift clock for SEG driver   | 36              | P3.0              |
| TCLO0                                | I/O      | Timer/counter0 clock output   | 36              | P3.0              |
| TCLO1                                | I/O      | Timer/counter1 clock output   | 37              | P3.1              |
| TCL0                                 | I/O      | External clock input for timer/counter 0  | 38              | P3.2              |
| TCL1                                 | I/O      | External clock input for timer/counter 1  | 39              | P3.3              |
| CIN0-CIN2                            | I/O      | CIN0,1: comparator input only<br>CIN2: comparator input or external reference input | 40, 41<br>42    | P4.0-P4.1<br>P4.2 |
| SEG0-SEG47                           | 0        | LCD segment data output   | 122–75          | -                 |
| SEG48-SEG79                          | 0        | LCD segment data output   | 74–43           | Port13-6          |
| SEG80-SEG87                          | 0        | LCD segment data output   | 2,1,<br>128–123 | COM15-8           |
| COM0-COM7                            | 0        | LCD common data output  | 10–3            | _                 |
| COM8-COM15                           | 0        | LCD common data output  | 123–128<br>1, 2 | SEG87-80          |
| V <sub>LC1</sub> -V <sub>LC5</sub>   | _        | LCD power supply. Voltage dividing resistors are fixed.                             | 15–11           | _                 |
| V <sub>DD</sub>                      | _        | Main power supply   | 20              | _                 |
| V <sub>SS</sub>                      | _        | Ground  | 21              | _                 |
| X <sub>IN</sub> , X <sub>OUT</sub>   | _        | Crystal, Ceramic, or RC oscillator signal I/O for main system clock.                | 23, 22          | _                 |
| XT <sub>IN</sub> , XT <sub>OUT</sub> | -        | Crystal oscillator signal I/O for subsystem clock.                                  | 25, 26          | -                 |
| TEST                                 | I        | Test signal input (must be connected to V <sub>SS</sub> )                           | 24              | _                 |
| RESET                                | I        | Reset signal  | 27              | _                 |

**NOTE:** Pull-up resistors for all I/O ports are automatically disabled if they are configured to output mode.



Table 1-2. Overview of S3C72M5/C72M7/C72M9 Pin Data

| Pin Names                           | Share Pins             | I/O Type | Reset Value | Circuit Type |
|-------------------------------------|------------------------|----------|-------------|--------------|
| P0.0-P0.3                           | SCK, SO, SI, BUZ/K0-K3 | I/O      | Input       | E-2          |
| P1.0-P1.3                           | INT0-INT2, INT4        | I        | Input       | A-3          |
| P2.0-P2.3                           | M, LCDFR, CLO1, CLO2   | I/O      | Input       | E            |
| P3.0-P3.1                           | TCLO0/CL, TCLO1        | I/O      | Input       | E            |
| P3.2-P3.3                           | TCL0, TCL1             | I/O      | Input       | E-1          |
| P4.0-P4.2                           | CIN0-CIN2              | I/O      | Input       | F-4          |
| P6.0-P6.3                           | K4-K7/SEG79-SEG76      | I/O      | Input       | H-15         |
| P7.0-P7.3                           | SEG75-SEG72            | I/O      | Input       | H-8          |
| P8.0-P8.3                           | SEG71-SEG68            | I/O      | Input       | H-8          |
| P9.0-P9.3                           | SEG67-SEG64            | I/O      | Input       | H-8          |
| P10.0-P10.3                         | SEG63-SEG60            | I/O      | Input       | H-8          |
| P11.0-P11.3                         | SEG59-SEG56            | I/O      | Input       | H-8          |
| P12.0-P12.3                         | SEG55-SEG52            | I/O      | Input       | H-8          |
| P13.0-P13.3                         | SEG51-SEG48            | I/O      | Input       | H-8          |
| COM0-COM7                           | _                      | 0        | Low output  | H-4          |
| COM8-COM15                          | SEG87-SEG80            | 0        | Low output  | H-6          |
| SEG0-SEG47                          | _                      | 0        | Low output  | H-5          |
| V <sub>LC1</sub> –V <sub>LC5</sub>  | -                      | _        | _           | _            |
| V <sub>DD</sub>                     | -                      | _        | _           | _            |
| V <sub>SS</sub>                     | -                      | -        | _           | _            |
| X <sub>IN</sub> , X <sub>OUT</sub>  | -                      | _        | _           | _            |
| XT <sub>IN,</sub> XT <sub>OUT</sub> | -                      | _        | _           | _            |
| RESET                               | -                      | I        |             | В            |
| TEST                                | _                      | I        | _           | _            |



# **PIN CIRCUIT DIAGRAMS**

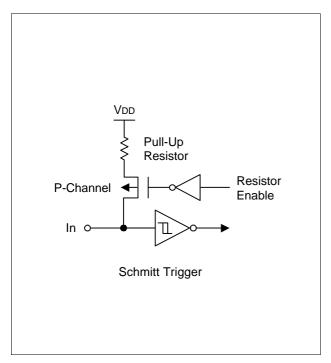


Figure 1-3. Pin Circuit Type A-3

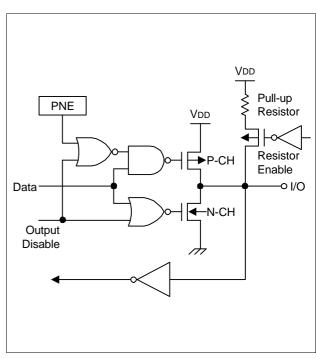


Figure 1-5. Pin Circuit Type E

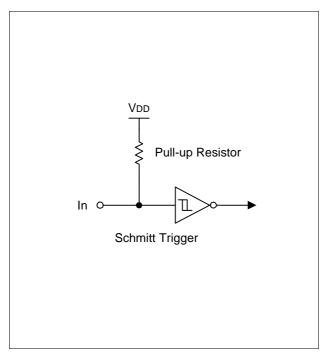


Figure 1-4. Pin Circuit Type B

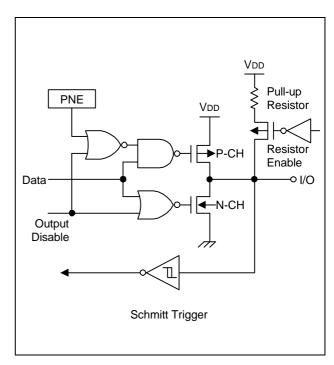


Figure 1-6. Pin Circuit Type E-1



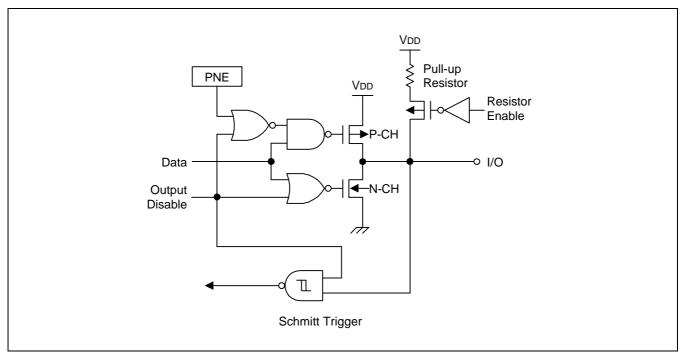


Figure 1-7. Pin Circuit Type E-2

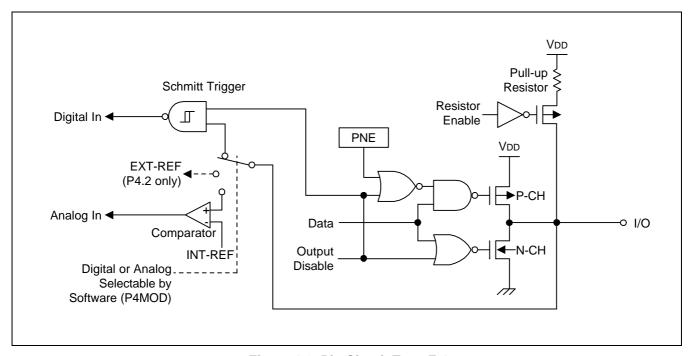


Figure 1-8. Pin Circuit Type F-4



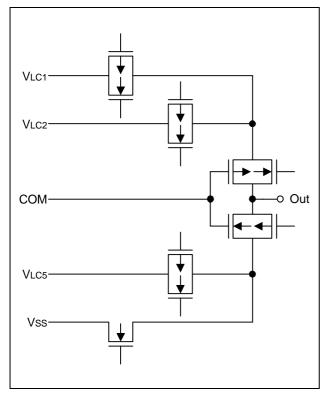


Figure 1-9. Pin Circuit Type H-4

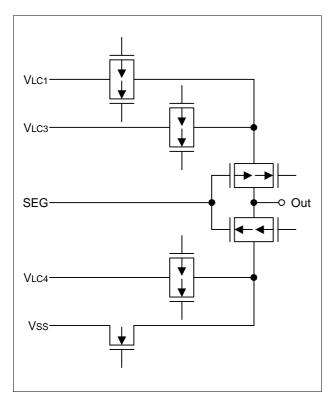


Figure 1-10. Pin Circuit Type H-5

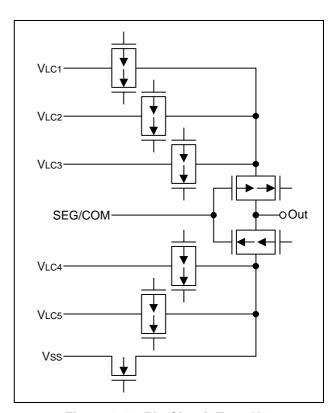


Figure 1-11. Pin Circuit Type H-6

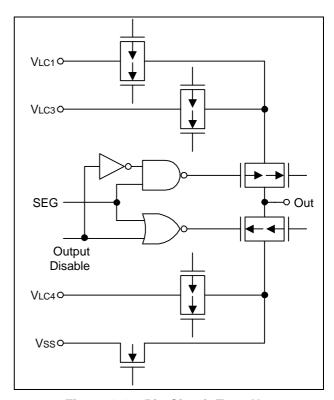


Figure 1-12. Pin Circuit Type H-7



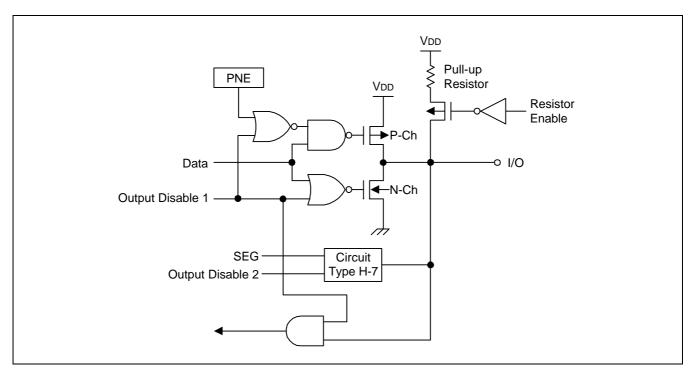


Figure 1-13. Pin Circuit Type H-8

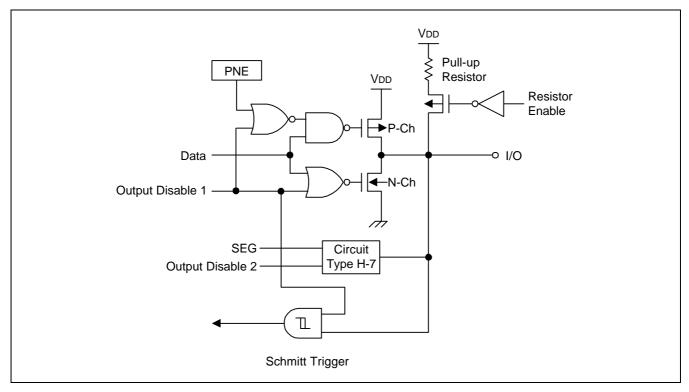


Figure 1-14. Pin Circuit Type H-15



# 15 ELECTRICAL DATA

# **OVERVIEW**

In this section, information on S3C72M5/C72M7/C72M9 electrical characteristics is presented as tables and graphics. The information is arranged in the following order:

# **Standard Electrical Characteristics**

- Absolute maximum ratings
- D.C. electrical characteristics
- Main system clock oscillator characteristics
- Subsystem clock oscillator characteristics
- I/O capacitance
- Comparator electrical characteristics
- LCD contrast controller characteristics
- A.C. electrical characteristics
- Operating voltage range

# **Stop Mode Characteristics and Timing Waveforms**

- RAM data retention supply voltage in stop mode
- Stop mode release timing when initiated by RESET
- Stop mode release timing when initiated by an interrupt request

# **Miscellaneous Timing Waveforms**

- A.C timing measurement points
- Clock timing measurement at X<sub>IN</sub>
- Clock timing measurement at XT<sub>IN</sub>
- TCL0/TCL1 timing
- Input timing for RESET signal
- Input timing for external interrupts and quasi-interrupts
- Serial data transfer timing



**Table 15-1. Absolute Maximum Ratings** 

 $(T_A = 25 \,^{\circ}C)$ 

| Parameter             | Symbol           | Conditions             | Rating                   | Units |
|-----------------------|------------------|------------------------|--------------------------|-------|
| Supply Voltage        | V <sub>DD</sub>  | -                      | -0.3 to $+6.5$           | V     |
| Input Voltage         | V <sub>I</sub>   | All I/O pins active    | $-0.3$ to $V_{DD} + 0.3$ | V     |
| Output Voltage        | Vo               | -                      | $-0.3$ to $V_{DD} + 0.3$ | V     |
| Output Current High   | I <sub>OH</sub>  | One I/O pin active     | -15                      | mA    |
|                       |                  | All I/O pins active    | -35                      |       |
| Output Current Low    | I <sub>OL</sub>  | One I/O pin active     | + 30 (Peak value)        | mA    |
|                       |                  |                        | + 15 <sup>(note)</sup>   |       |
|                       |                  | Total for ports 0, 2–9 | + 100 (Peak value)       |       |
|                       |                  |                        | + 60 <sup>(note)</sup>   |       |
| Operating Temperature | T <sub>A</sub>   | -                      | -40 to +85               | °C    |
| Storage Temperature   | T <sub>stg</sub> | -                      | -65 to +150              | °C    |

**NOTE**: The values for Output Current Low (  $I_{OL}$  ) are calculated as Peak Value  $\times$   $\sqrt{\text{Duty}}$  .

# **Table 15-2. D.C. Electrical Characteristics**

 $(T_A = -40 \,^{\circ}\text{C to } + 85 \,^{\circ}\text{C}, V_{DD} = 1.8 \,\text{V to } 5.5 \,\text{V})$ 

| Parameter              | Symbol           | Conditions  | Min                   | Тур | Max                 | Units |
|------------------------|------------------|---|-----------------------|-----|---------------------|-------|
| Input High<br>Voltage  | V <sub>IH1</sub> | All input pins except those specified below for V <sub>IH2</sub> –V <sub>IH3</sub>            |                       |     | V <sub>DD</sub>     | V     |
|                        | V <sub>IH2</sub> | Ports 0, 1, 4, 6, P3.2, P3.3, and RESET   | 0.8 V <sub>DD</sub>   |     | V <sub>DD</sub>     |       |
|                        | V <sub>IH3</sub> | $X_{IN}$ , $X_{OUT}$ , $XT_{IN}$ , and $XT_{OUT}$   | $V_{DD} - 0.1$        |     | $V_{DD}$            |       |
| Input Low<br>Voltage   | V <sub>IL1</sub> | All input pins except those specified below for V <sub>IL2</sub> –V <sub>IL3</sub>            | _                     | -   | 0.3 V <sub>DD</sub> | V     |
|                        | V <sub>IL2</sub> | Ports 0, 1, 4, 6, P3.2, P3.3, and RESET   |                       |     | 0.2 V <sub>DD</sub> |       |
|                        | V <sub>IL3</sub> | $X_{IN}$ , $X_{OUT}$ , $XT_{IN}$ , and $XT_{OUT}$   |                       |     | 0.1                 |       |
| Output High<br>Voltage | V <sub>OH</sub>  | $V_{DD} = 4.5 \text{ V}$ to 5.5 V<br>$I_{OH} = -1 \text{ mA}$<br>Ports 0, 2, 3, 4, ports 6–13 | V <sub>DD</sub> – 1.0 | -   | _                   | V     |
| Output Low<br>Voltage  | V <sub>OL</sub>  | $V_{DD} = 4.5 \text{ V}$ to 5.5 V $I_{OL} = 15 \text{ mA}$                                    | _                     | -   | 2.0                 | V     |
| İ                      |                  | Ports 0, 2, 3, 4, ports 6–13  | <br>                  |     |                     | ,     |
|                        |                  | $V_{DD} = 1.8 \text{ V}$ to 5.5 V<br>$I_{OL} = 1.6 \text{ mA}$                                |                       |     | 0.4                 |       |



Table 15-2. D.C. Electrical Characteristics (Continued)

 $(T_A = -40 \,^{\circ}\text{C} \text{ to } + 85 \,^{\circ}\text{C}, \, V_{DD} = 1.8 \,^{\circ}\text{V} \text{ to } 5.5 \,^{\circ}\text{V})$ 

| Parameter   | Symbol            | Conditions   | Min                      | Тур                 | Max                      | Units |
|---|-------------------|--|--------------------------|---------------------|--------------------------|-------|
| Input High<br>Leakage<br>Current                      | I <sub>LIH1</sub> | $V_I = V_{DD}$<br>All input pins except those specified below for $I_{LIH2}$                     | -                        | _                   | 3                        | μА    |
|   | I <sub>LIH2</sub> | $V_I = V_{DD}$<br>$X_{IN}, X_{OUT}, XT_{IN}, and XT_{OUT}$                                       |                          |                     | 20                       |       |
| Input Low<br>Leakage<br>Current                       | I <sub>LIL1</sub> | $V_I = 0 V$<br>All input pins except RESET,<br>$X_{IN}$ , $X_{OUT}$ , $XT_{IN}$ , and $XT_{OUT}$ |                          | _                   | -3                       | μA    |
|   | I <sub>LIL2</sub> | $V_I = 0 V$<br>RESET, $X_{IN}$ , $X_{OUT}$ , $XT_{IN}$ , and $XT_{OUT}$                          |                          |                     | -20                      |       |
| Output High<br>Leakage<br>Current                     | I <sub>LOH</sub>  | $V_O = V_{DD}$<br>All output pins  | -                        | _                   | 3                        | μA    |
| Output Low<br>Leakage<br>Current                      | I <sub>LOL</sub>  | V <sub>O</sub> = 0 V<br>All output pins  | _                        | _                   | -3                       | μA    |
| Pull-Up<br>Resistor                                   | R <sub>LI</sub>   | V <sub>I</sub> = 0 V; V <sub>DD</sub> = 5 V<br>Ports 0–4, ports 6–13                             | 25                       | 50                  | 100                      | kΩ    |
|   |                   | $V_{DD} = 3 V$   | 50                       | 100                 | 200                      |       |
|   | R <sub>L2</sub>   | $V_I = 0 \text{ V}; V_{DD} = 5 \text{ V}, \text{RESET}$  | 100                      | 250                 | 400                      |       |
|   |                   | $V_{DD} = 3 V$   | 200                      | 500                 | 800                      |       |
| LCD Voltage<br>Dividing<br>Resistor                   | R <sub>LCD</sub>  | -  | 40                       | 60                  | 90                       | kΩ    |
| V <sub>LC1</sub> -COMi <br>Voltage Drop<br>(i = 0–15) | V <sub>DC</sub>   | –15 μA per common pin  | -                        | _                   | 120                      | mV    |
| $ V_{LC1}$ -SEGx <br>Voltage Drop<br>(x = 0-79)       | V <sub>DS</sub>   | –15 μA per segment pin   | _                        | _                   | 120                      |       |
| V <sub>LC2</sub> Output<br>Voltage                    | V <sub>LC2</sub>  | $V_{DD}$ = 1.8 V to 5.5 V, 1/5 bias<br>LCD clock = 0 Hz, $V_{LC1}$ = $V_{DD}$                    | 0.8 V <sub>DD</sub> -0.2 | 0.8 V <sub>DD</sub> | 0.8 V <sub>DD</sub> -0.2 | V     |
| V <sub>LC3</sub> Output<br>Voltage                    | V <sub>LC3</sub>  |  | 0.6 V <sub>DD</sub> -0.2 | 0.6 V <sub>DD</sub> | 0.6 V <sub>DD</sub> -0.2 |       |
| V <sub>LC4</sub> Output<br>Voltage                    | V <sub>LC4</sub>  |  | 0.4 V <sub>DD</sub> -0.2 | 0.4 V <sub>DD</sub> | 0.4 V <sub>DD</sub> -0.2 | -     |
| V <sub>LC5</sub> Output<br>Voltage                    | V <sub>LC5</sub>  |  | 0.2 V <sub>DD</sub> -0.2 | 0.2 V <sub>DD</sub> | 0.2 V <sub>DD</sub> -0.2 |       |



Table 15-2. D.C. Electrical Characteristics (Concluded)

 $(T_A = -40 \,^{\circ}\text{C} \text{ to } + 85 \,^{\circ}\text{C}, V_{DD} = 1.8 \,^{\circ}\text{V} \text{ to } 5.5 \,^{\circ}\text{V})$ 

| Parameter                        | Symbol                          | Condition   | ns  | Min | Тур         | Max        | Units |
|----------------------------------|---------------------------------|---|---|-----|-------------|------------|-------|
| Supply<br>Current <sup>(1)</sup> | I <sub>DD1</sub> (2)            | V <sub>DD</sub> = 5 V ± 10%<br>Crystal oscillator<br>C1 = C2 = 22 pF                  | 6.0 MHz<br>4.19 MHz                       | _   | 3.9<br>2.9  | 8.0<br>5.5 | mA    |
|                                  |                                 | V <sub>DD</sub> = 3 V ± 10%   | 6.0 MHz<br>4.19 MHz                       |     | 1.8<br>1.3  | 4.0<br>3.0 |       |
|                                  | I <sub>DD2</sub> <sup>(2)</sup> | Idle mode<br>$V_{DD} = 5 \text{ V} \pm 10\%$<br>Crystal oscillator<br>C1 = C2 = 22 pF | 6.0 MHz<br>4.19 MHz                       |     | 1.3<br>1.2  | 2.5<br>1.8 |       |
|                                  |                                 | $V_{DD} = 3 \text{ V} \pm 10\%$   | 6.0 MHz<br>4.19 MHz                       |     | 0.5<br>0.44 | 1.5<br>1.0 |       |
|                                  | I <sub>DD3</sub> (3)            | $V_{DD} = 3 V \pm 10\%$<br>32 kHz crystal oscilla                                     | itor                                      | _   | 15.3        | 30         | μΑ    |
|                                  | I <sub>DD4</sub> (3)            | Idle mode; V <sub>DD</sub> = 3 V<br>32 kHz crystal oscilla                            |   |     | 6.4         | 15         |       |
|                                  | I <sub>DD5</sub>                | Stop mode;<br>V <sub>DD</sub> = 5 V ± 10%   | SCMOD =<br>0000B<br>XT <sub>IN</sub> = 0V |     | 2.5         | 5          |       |
|                                  |                                 | Stop mode;<br>V <sub>DD</sub> = 3 V ± 10%   |   |     | 0.5         | 3          |       |
|                                  |                                 | V <sub>DD</sub> = 5 V ± 10%   | SCMOD = 0100B                             |     | 0.2         | 3          |       |
|                                  |                                 | $V_{DD} = 3 V \pm 10\%$   |   |     | 0.1         | 2          |       |

- 1. Currents in the following circuits are not included; on-chip pull-up resistors, internal LCD voltage dividing resistors, output port drive currents.
- 2. Data includes power consumption for subsystem clock oscillation.
- 3. When the system clock control register, SCMOD, is set to 1001B, main system clock oscillation stops and the subsystem clock is used.
- 4. Every values in this table is measured when the power control register (PCON) is set to "0011B".



**Table 15-3. Main System Clock Oscillator Characteristics** 

$$(T_A = -40 \,^{\circ}C + 85 \,^{\circ}C, V_{DD} = 1.8 \,^{\circ}V \text{ to } 5.5 \,^{\circ}V)$$

| Oscillato<br>r        | Clock<br>Configuration | Parameter   | Test Condition  | Min  | Тур | Max  | Units |
|-----------------------|------------------------|---|---|------|-----|------|-------|
| Ceramic<br>Oscillator | XIN XOUT  C1 C2        | Oscillation frequency (1)   | _   | 0.4  | _   | 6.0  | MHz   |
|                       |                        | Stabilization time (2)  | Stabilization occurs when $V_{DD}$ is equal to the minimum oscillator voltage range; $V_{DD} = 3.0 \text{ V}$ . | _    | _   | 4    | ms    |
| Crystal<br>Oscillator | XIN XOUT  C1 C2        | Oscillation frequency (1)   | _   | 0.4  | _   | 6.0  | MHz   |
|                       |                        | Stabilization time (2)  | V <sub>DD</sub> = 2.7 V to 5.5 V  | _    | _   | 10   | ms    |
|                       |                        |   | $V_{DD} = 1.8 \text{ V to } 5.5 \text{ V}$  | _    | _   | 30   |       |
| External<br>Clock     | XIN XOUT               | X <sub>IN</sub> input frequency <sup>(1)</sup>                                      | _   | 0.4  | _   | 6.0  | MHz   |
|                       |                        | X <sub>IN</sub> input high and low level width (t <sub>XH</sub> , t <sub>XL</sub> ) | -   | 83.3 | _   | 1250 | ns    |
| RC<br>Oscillator      | XIN XOUT               | Frequency   | $R = 20 \text{ k}\Omega$ , $V_{DD} = 5 \text{ V}$   | _    | 2   | _    | MHz   |
|                       |                        |   | $R = 39 \text{ k}\Omega,$ $V_{DD} = 3 \text{ V}$  | _    | 1   | _    |       |

- 1. Oscillation frequency and  $X_{\mbox{\footnotesize{IN}}}$  input frequency data are for oscillator characteristics only.
- 2. Stabilization time is the interval required for oscillating stabilization after a power-on occurs, or when stop mode is terminated.



Table 15-4. Subsystem Clock Oscillator Characteristics

$$(T_A = -40 \,^{\circ}C + 85 \,^{\circ}C, V_{DD} = 1.8 \,^{\circ}V \text{ to } 5.5 \,^{\circ}V)$$

| Oscillator            | Clock<br>Configuration | Parameter  | Test Condition                             | Min | Тур    | Max | Units |
|-----------------------|------------------------|--|--|-----|--------|-----|-------|
| Crystal<br>Oscillator | XTIN XTOUT C2          | Oscillation frequency (1)  | _  | 32  | 32.768 | 35  | kHz   |
|                       |                        | Stabilization time (2)   | $V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$ | _   | 1.0    | 2   | S     |
|                       |                        |  | $V_{DD} = 1.8 \text{ V to } 5.5 \text{ V}$ | -   | _      | 10  |       |
| External<br>Clock     | XTIN XTOUT             | XT <sub>IN</sub> input frequency <sup>(1)</sup>  | _  | 32  | -      | 100 | kHz   |
|                       |                        | XT <sub>IN</sub> input high and low level width (t <sub>XTL</sub> , t <sub>XTH</sub> ) | -  | 5   | -      | 15  | μs    |

- 1. Oscillation frequency and  ${\rm XT}_{\rm IN}$  input frequency data are for oscillator characteristics only.
- 2. Stabilization time is the interval required for oscillating stabilization after a power-on occurs.



# Table 15-5. Input/Output Capacitance

$$(T_A = 25 \,^{\circ}C, V_{DD} = 0 \, V)$$

| Parameter             | Symbol           | Condition  | Min | Тур | Max | Units |
|-----------------------|------------------|--|-----|-----|-----|-------|
| Input<br>Capacitance  | C <sub>IN</sub>  | f = 1 MHz; Unmeasured pins are returned to V <sub>SS</sub> | _   | _   | 15  | pF    |
| Output<br>Capacitance | C <sub>OUT</sub> |  | _   | _   | 15  | pF    |
| I/O Capacitance       | C <sub>IO</sub>  |  | _   | _   | 15  | pF    |

# **Table 15-6. Comparator Electrical Characteristics**

(T<sub>A</sub> = 
$$-40\,^{\circ}$$
C + 85  $^{\circ}$ C, V<sub>DD</sub> = 4.0 V to 5.5 V, V<sub>SS</sub> = 0 V)

| Parameter               |                     | Symbol                              | Condition | Min | Тур | Max             | Units |
|-------------------------|---------------------|-------------------------------------|-----------|-----|-----|-----------------|-------|
| Input Voltage R         | Input Voltage Range |                                     | -         | 0   | _   | V <sub>DD</sub> | V     |
| Reference Voltage Range |                     | V <sub>REF</sub>                    | -         | 0   | _   | V <sub>DD</sub> | V     |
| Input Voltage           | Internal            | V <sub>CIN1</sub>                   | -         | _   | _   | ± 150           | mV    |
| Accuracy                | External            | V <sub>CIN2</sub>                   | -         | _   | _   | ± 150           | mV    |
| Input Leakage           | Current             | I <sub>CIN</sub> , I <sub>REF</sub> | -         | -3  | _   | 3               | μΑ    |

# **Table 15-7. LCD Contrast Controller Characteristics**

$$(T_A = -40 \,^{\circ}C + 85 \,^{\circ}C, V_{DD} = 4.5 \,^{\circ}V \text{ to } 5.5 \,^{\circ}V)$$

| Parameter                            | Symbol           | Condition                             | Min | Тур | Max              | Units |
|--------------------------------------|------------------|---------------------------------------|-----|-----|------------------|-------|
| Resolution                           | _                | _                                     | _   | _   | 4                | Bits  |
| Linearity                            | RLIN             | _                                     | -   | _   | ± 1.0            | LSB   |
| Max Output Voltage<br>(LCNST = #8FH) | V <sub>LPP</sub> | V <sub>LC1</sub> =V <sub>DD</sub> =5V | 4.9 | _   | V <sub>LC1</sub> | V     |



# Table 15-8. A.C. Electrical Characteristics

 $(T_A = -40 \,^{\circ}\text{C} \text{ to } + 85 \,^{\circ}\text{C}, V_{DD} = 1.8 \,\text{V} \text{ to } 5.5 \,\text{V})$ 

| Parameter                                   | Symbol  | Conditions  | Min                       | Тур | Max | Units |
|---|---|---|---------------------------|-----|-----|-------|
| Instruction Cycle<br>Time <sup>(note)</sup> | t <sub>CY</sub>   | $V_{DD} = 2.7 \text{ V} \text{ to } 5.5 \text{ V}$                | 0.67                      | -   | 64  | μs    |
|   |   | $V_{DD} = 1.8 \text{ V} \text{ to } 5.5 \text{ V}$                | 0.95                      |     | 64  |       |
| TCL0, TCL1 Input<br>Frequency               | f <sub>TIO</sub> , f <sub>TI1</sub>   | V <sub>DD</sub> = 2.7 V to 5.5 V                                  | 0                         | _   | 1.5 | MHz   |
|   |   | V <sub>DD</sub> = 1.8 V to 5.5 V                                  |                           |     | 1   |       |
| TCL0, TCL1 Input<br>High, Low Width         | t <sub>TIH0</sub> , t <sub>TIL0</sub> t <sub>TIH1</sub> , t <sub>TIL1</sub> | $V_{DD} = 2.7 \text{ V} \text{ to } 5.5 \text{ V}$                | 0.48                      | -   | _   | μs    |
|   |   | V <sub>DD</sub> = 1.8 V to 5.5 V                                  | 1.8                       |     |     |       |
| SCK Cycle Time                              | t <sub>KCY</sub>  | $V_{DD} = 2.7 \text{ V}$ to 5.5 V; Input                          | 800                       | -   | _   | ns    |
|   |   | Output  | 650                       |     |     |       |
|   |   | V <sub>DD</sub> = 1.8 V to 5.5 V; Input                           | 3200                      |     |     |       |
|   |   | Output  | 3800                      |     |     |       |
| SCK High, Low<br>Width                      | t <sub>KH</sub> , t <sub>KL</sub>   | $V_{DD} = 2.7 \text{ V}$ to 5.5 V; Input                          | 325                       | _   | _   | ns    |
|   |   | Output  | t <sub>KCY</sub> /2 - 50  |     |     |       |
|   |   | $V_{DD} = 1.8 \text{ V} \text{ to } 5.5 \text{ V}; \text{ Input}$ | 1600                      |     |     |       |
|   |   | Output  | t <sub>KCY</sub> /2 – 150 |     |     |       |
| SI Setup Time to<br>SCK High                | t <sub>SIK</sub>  | $V_{DD} = 2.7 \text{ V}$ to 5.5 V; Input                          | 100                       | _   | _   | ns    |
|   |   | $V_{DD} = 2.7 \text{ V}$ to 5.5 V; Output                         | 150                       |     |     |       |
|   |   | $V_{DD} = 1.8 \text{ V} \text{ to } 5.5 \text{ V}; \text{Input}$  | 150                       |     |     |       |
|   |   | V <sub>DD</sub> = 1.8 V to 5.5 V; Output                          | 500                       |     |     |       |
| SI Hold Time to<br>SCK High                 | tksi  | $V_{DD} = 2.7 \text{ V}$ to 5.5 V; Input                          | 400                       | _   | _   | ns    |
|   |   | $V_{DD} = 2.7 \text{ V}$ to 5.5 V; Output                         | 400                       |     |     |       |
|   |   | $V_{DD} = 1.8 \text{ V}$ to 5.5 V; Input                          | 600                       |     |     |       |
|   |   | V <sub>DD</sub> = 1.8 V to 5.5 V; Output                          | 500                       |     |     |       |

**NOTE:** Unless otherwise specified, Instruction Cycle Time condition values assume a main system clock (fx) source.



Table 15-8. A.C. Electrical Characteristics (Continued)

$$(T_A = -40 \,^{\circ}\text{C} \text{ to } + 85 \,^{\circ}\text{C}, V_{DD} = 1.8 \,\text{V} \text{ to } 5.5 \,\text{V})$$

| Parameter                          | Symbol                                | Conditions   | Min | Тур | Max  | Units |
|------------------------------------|---------------------------------------|--|-----|-----|------|-------|
| Output Delay for SCK to SO         | t <sub>KSO</sub>                      | $V_{DD} = 2.7 \text{ V} \text{ to } 5.5 \text{ V}; \text{Input}$ | _   | _   | 300  | ns    |
|                                    |                                       | $V_{DD} = 2.7 \text{ V}$ to 5.5 V; Output                        |     |     | 250  |       |
|                                    |                                       | $V_{DD} = 1.8 \text{ V to } 5.5 \text{ V; Input}$                |     |     | 1000 |       |
|                                    |                                       | $V_{DD} = 1.8 \text{ V}$ to 5.5 V; Output                        |     |     | 1000 |       |
| Interrupt Input<br>High, Low Width | t <sub>INTH</sub> , t <sub>INTL</sub> | INTO, INT1, INT2, INT4,<br>K0–K7                                 | 10  | _   | _    | μs    |
| RESET Input Low<br>Width           | t <sub>RSL</sub>                      | Input  | 10  | _   | _    | μs    |

NOTE: Minimum value for INT0 is based on a clock of  $2t_{CY}$  or 128 / fx as assigned by the IMOD0 register setting.

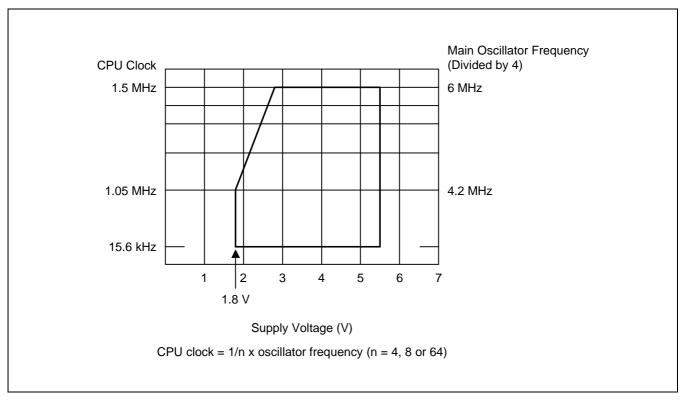


Figure 15-1. Standard Operating Voltage Range



Table 15-9. RAM Data Retention Supply Voltage in Stop Mode

$$(T_A = -40 \,^{\circ}\text{C to} + 85 \,^{\circ}\text{C})$$

| Parameter                                       | Symbol            | Conditions                | Min | Тур                  | Max | Unit |
|---|-------------------|---------------------------|-----|----------------------|-----|------|
| Data retention supply voltage V <sub>DDDR</sub> |                   | _                         | 1.8 | _                    | 5.5 | V    |
| Data retention supply current                   | I <sub>DDDR</sub> | V <sub>DDDR</sub> = 1.8 V | _   | 0.1                  | 1   | μA   |
| Release signal set time                         | t <sub>SREL</sub> | _                         | 0   | _                    | _   | μs   |
| Oscillator stabilization wait t <sub>W</sub>    |                   | Released by RESET         | _   | 2 <sup>17</sup> / fx | -   | ms   |
|   |                   | Released by interrupt     | _   | (2)                  | _   |      |

- 1. During oscillator stabilization wait time, all CPU operations must be stopped to avoid instability during oscillator start-up.
- 2. Use the basic timer mode register (BMOD) interval timer to delay execution of CPU instructions during the wait time.



# **TIMING WAVEFORMS**

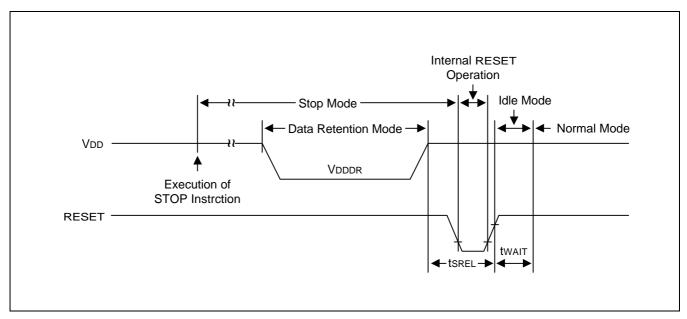


Figure 15-2. Stop Mode Release Timing When Initiated By RESET

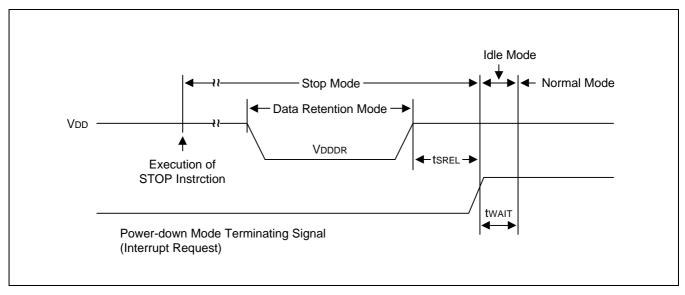


Figure 15-3. Stop Mode Release Timing When Initiated By Interrupt Request

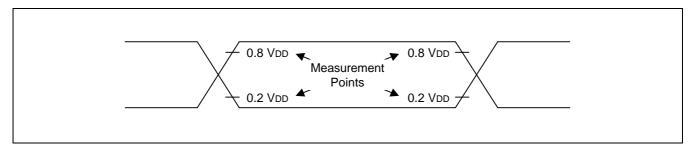


Figure 15-4. A.C. Timing Measurement Points (Except for X<sub>IN</sub> and XT<sub>IN</sub>)

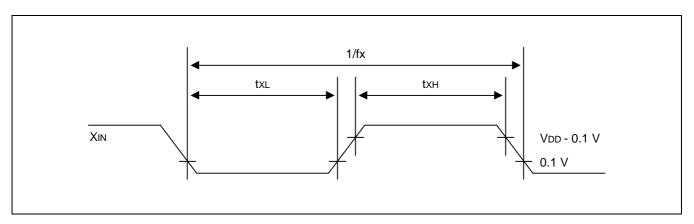


Figure 15-5. Clock Timing Measurement at X<sub>IN</sub>

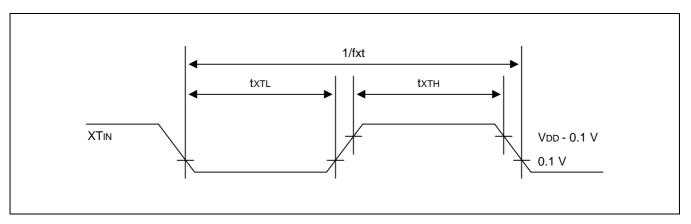


Figure 15-6. Clock Timing Measurement at  $\mathrm{XT}_{\mathrm{IN}}$ 

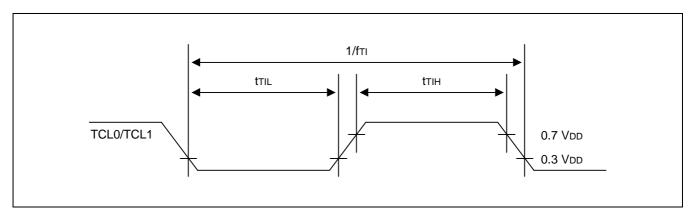


Figure 15-7. TCL0/TCL1 Timing

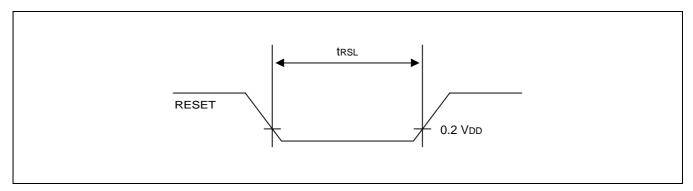


Figure 15-8. Input Timing for RESET Signal

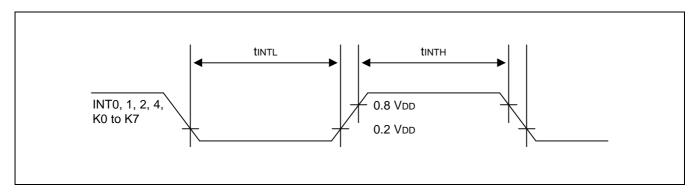


Figure 15-9. Input Timing for External Interrupts and Quasi-Interrupts

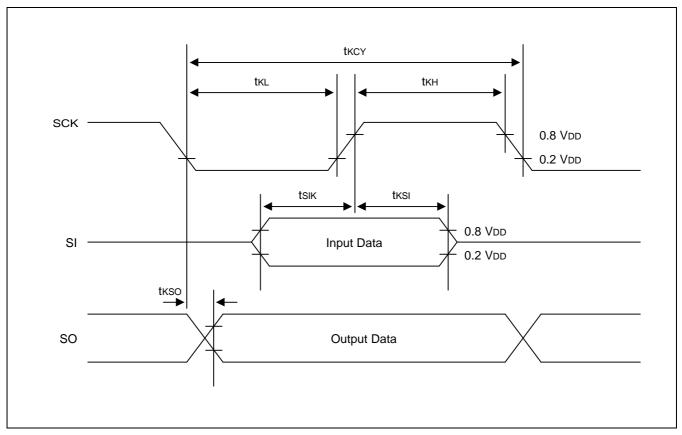


Figure 15-10. Serial Data Transfer Timing



# 16 MECHANICAL DATA

# **OVERVIEW**

The S3C72M5/C72M7/C72M9/P72M9 microcontroller is currently available in a 128-pin QFP package.

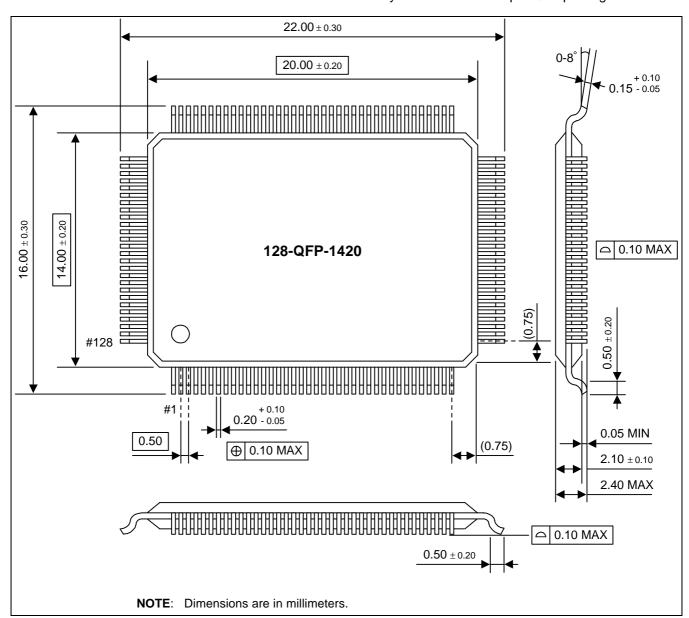


Figure 16-1. 128-QFP-1420 Package Dimensions



16-1



# **17** S3P72M9 OTP

# **OVERVIEW**

The S3P72M9 single-chip CMOS microcontroller is the OTP (One Time Programmable) version of the S3C72M5/C72M7/C72M9 microcontroller. It has an on-chip OTP ROM instead of masked ROM. The EPROM is accessed by serial data format.

The S3P72M9 is fully compatible with the S3C72M5/C72M7/C72M9, both in function and in pin configuration except ROM size. Because of its simple programming requirements, the S3P72M9 is ideal for use as an evaluation chip for the S3C72M5/C72M7/C72M9.



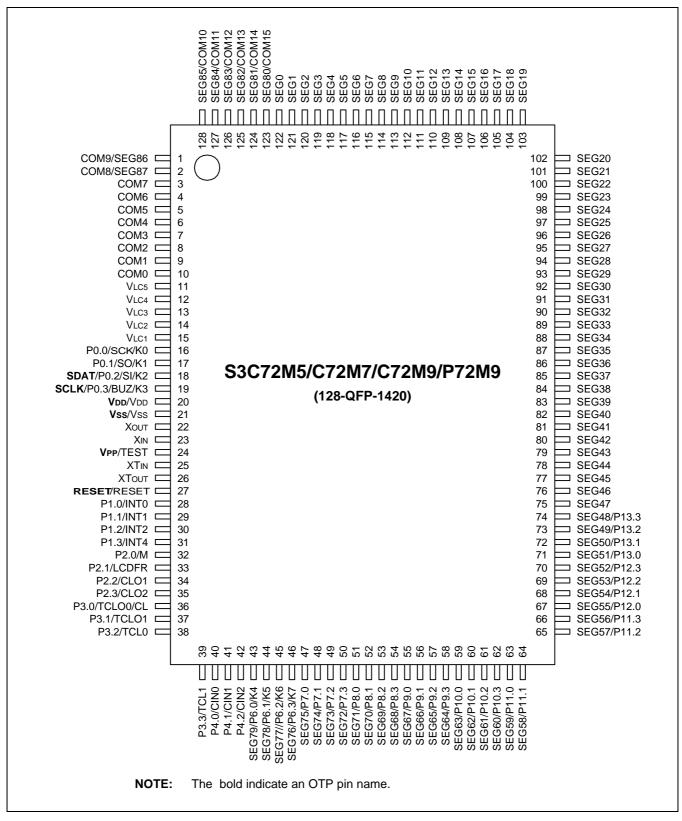


Figure 17-1. S3P72M9 Pin Assignments (128-QFP Package)



Table 17-1. Descriptions of Pins Used to Read/Write the EPROM

| Main Chip                        | During Programming               |         |     |   |  |  |  |
|----------------------------------|----------------------------------|---------|-----|---|--|--|--|
| Pin Name                         | Pin Name                         | Pin No. | I/O | Function  |  |  |  |
| P0.2                             | SDAT                             | 18      | I/O | Serial data pin. Output port when reading and input port when writing. Can be assigned as a Input/push-pull output port.  |  |  |  |
| P0.3                             | SCLK                             | 19      | I/O | Serial clock pin. Input only pin.   |  |  |  |
| TEST                             | V <sub>PP</sub> (TEST)           | 24      | I   | Power supply pin for EPROM cell writing (indicates that OTP enters into the writing mode). When 12.5 V is applied, OTP is in writing mode and when 5 V is applied, OTP is in reading mode. (Option) |  |  |  |
| RESET                            | RESET                            | 27      | I   | Chip Initialization   |  |  |  |
| V <sub>DD</sub> /V <sub>SS</sub> | V <sub>DD</sub> /V <sub>SS</sub> | 20/21   | I   | Logic power supply pin. V <sub>DD</sub> should be tied to +5 V during programming.  |  |  |  |

Table 17-2. Comparison of S3P72M9 and S3C72M5/C72M7/C72M9 Features

| Characteristic                       | S3P72M9                                   | S3C72M5/C72M7/C72M9       |
|--------------------------------------|---|---------------------------|
| Program Memory                       | 32-Kbyte EPROM                            | 16/24/32-Kbyte mask ROM   |
| Operating Voltage (V <sub>DD</sub> ) | 1.8 V to 5.5 V                            | 1.8 V to 5.5 V            |
| OTP Programming Mode                 | V <sub>DD</sub> = 5 V, VPP (TEST) = 12.5V |                           |
| Pin Configuration                    | 128 QFP                                   | 128 QFP                   |
| EPROM Programmability                | User Program 1 time                       | Programmed at the factory |

# **OPERATING MODE CHARACTERISTICS**

When 12.5 V is supplied to the  $V_{PP}$  (TEST) pin of the S3P72M9, the EPROM programming mode is entered. The operating mode (read, write, or read protection) is selected according to the input signals to the pins listed in Table 17-3 below.

Table 17-3. Operating Mode Selection Criteria

| V <sub>DD</sub> | V <sub>PP</sub><br>(TEST) | REG/<br>MEM | Address<br>(A15-A0) | R/W | Mode                  |
|-----------------|---------------------------|-------------|---------------------|-----|-----------------------|
| 5 V             | 5 V                       | 0           | 0000H               | 1   | EPROM read            |
|                 | 12.5 V                    | 0           | 0000H               | 0   | EPROM program         |
|                 | 12.5 V                    | 0           | 0000H               | 1   | EPROM verify          |
|                 | 12.5 V                    | 1           | 0E3FH               | 0   | EPROM read protection |

NOTE: "0" means Low level; "1" means High level.



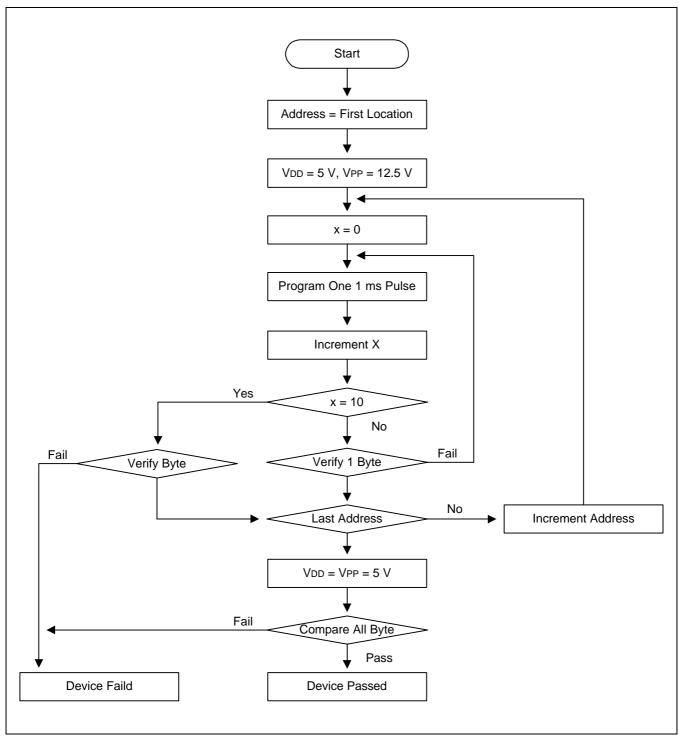


Figure 17-2. OTP Programming Algorithm

Table 17-4. D.C. Electrical Characteristics

$$(T_A = -40 \,^{\circ}C \text{ to } + 85 \,^{\circ}C, V_{DD} = 1.8 \,^{\circ}V \text{ to } 5.5 \,^{\circ}V)$$

| Parameter                        | Symbol               | Condition  | ıs  | Min | Тур         | Max        | Units |
|----------------------------------|----------------------|--|---|-----|-------------|------------|-------|
| Supply<br>Current <sup>(1)</sup> | I <sub>DD1</sub> (2) | $V_{DD} = 5 V \pm 10\%$<br>Crystal oscillator<br>C1 = C2 = 22 pF                       | 6.0 MHz<br>4.19 MHz                       | _   | 3.9<br>2.9  | 8.0<br>5.5 | mA    |
|                                  |                      | $V_{DD} = 3 V \pm 10\%$  | 6.0 MHz<br>4.19 MHz                       |     | 1.8<br>1.3  | 4.0<br>3.0 |       |
|                                  | I <sub>DD2</sub> (2) | Idle mode<br>$V_{DD} = 5 \text{ V} \pm 10\%$<br>Crystal oscillator<br>C1 = C2 = 22  pF | 6.0 MHz<br>4.19 MHz                       |     | 1.3<br>1.2  | 2.5<br>1.8 |       |
|                                  |                      | $V_{DD} = 3 V \pm 10\%$  | 6.0 MHz<br>4.19 MHz                       |     | 0.5<br>0.44 | 1.5<br>1.0 |       |
|                                  | I <sub>DD3</sub> (3) | V <sub>DD</sub> = 3 V ± 10%<br>32 kHz crystal oscillator                               |   | -   | 15.3        | 30         | μΑ    |
|                                  | I <sub>DD4</sub> (3) | Idle mode; V <sub>DD</sub> = 3 V<br>32 kHz crystal oscilla                             | 6.4                                       |     | 15          |            |       |
|                                  | I <sub>DD5</sub>     | Stop mode;<br>V <sub>DD</sub> = 5 V ± 10%  | SCMOD =<br>0000B<br>XT <sub>IN</sub> = 0V |     | 2.5         | 5          |       |
|                                  |                      | Stop mode;<br>V <sub>DD</sub> = 3 V ± 10%  |   |     | 0.5         | 3          |       |
|                                  |                      | $V_{DD} = 5 \text{ V} \pm 10\%$  | SCMOD = 0100B                             |     | 0.2         | 3          |       |
|                                  |                      | $V_{DD} = 3 V \pm 10\%$  |   |     | 0.1         | 2          |       |

- 1. Currents in the following circuits are not included; on-chip pull-up resistors, internal LCD voltage dividing resistors, output port drive currents.
- 2. Data includes power consumption for subsystem clock oscillation.
- 3. When the system clock control register, SCMOD, is set to 1001B, main system clock oscillation stops and the subsystem clock is used.
- 4. Every values in this table is measured when the power control register (PCON) is set to "0011B".

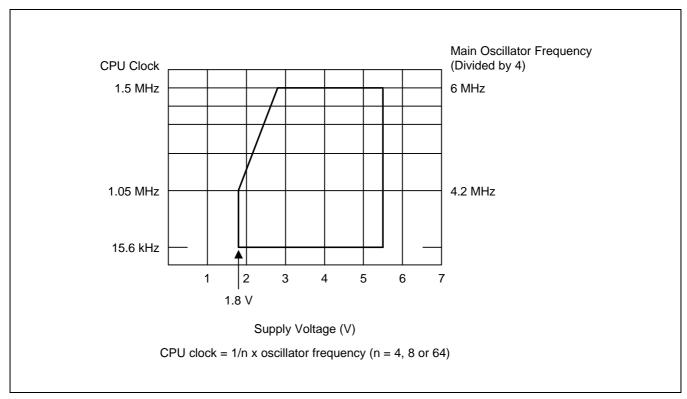


Figure 17-3. Standard Operating Voltage Range

